

SanRex®

TRIAC

For High Power

TG40E80

 $I_{T(RMS)} = 40A, V_{DRM} = 800V$

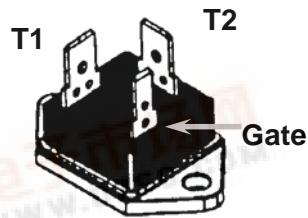
SanRex Triac **TG40E80** is specially designed use for high power AC switching application. Thanks to SanRex's new isolated diffusion technology, the Triac **TG40E80** features high dv/dt, dv/dt/c and very low on-state voltage. These benefits make this design an extremely reliable and efficient device for use in wide variety of applications.

Features

- * High Power
- * High Surge Current
- * Low On-State Voltage
- * High Commutation Performance
- * UL registered E76102

Typical Applications

- * Home Appliances
- * Water Heaters
- * Heater Controls
- * Lighting Controls
- * Temperature Controls



Isolated Fast-on Package



Internal schematic diagram

< Maximum Ratings >

(T_j = 25°C unless otherwise noted)

Symbol	Item	Conditions	Ratings	Unit
V _{DRM}	Repetitive Peak Off-state Voltage		800	V
I _{T(RMS)}	R.M.S. On-state Current	T _C = 64°C	40	A
I _{TSM}	Surge On-state Current	One cycle, 60Hz, Peak, non-repetitive	420	A
I ² t	I ² t (for fusing)	Value for one cycle surge current	730	A ² s
P _{GM}	Peak Gate Power Dissipation		10	W
P _{G(AV)}	Average Gate Power Dissipation		1	W
I _{GM}	Peak Gate Current		3	A
V _{GM}	Peak Gate Voltage		10	V
di/dt	Critical Rate of Rise of On-State Current	I _G = 100mA, V _D = 1/2V _{DRM} , di _G /dt = 1A/μs	50	A/μs
T _j	Operation Junction Temperature		-40 to +125	°C
T _{stg}	Storage Temperature		-40 to +150	°C
V _{iso}	Isolation Breakdown Voltage	R.M.S., A.C. 1 minute	2500	V
	Mounting Torque (M4)	Recommended value 1.0 – 1.4 N*m	1.5	N*m
	Mass	Typical Value	23	g

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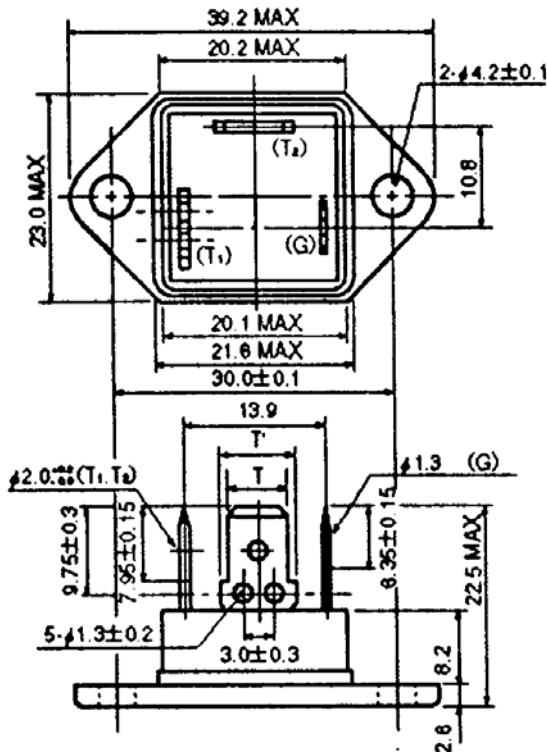
TRIAC for High Power

TG40E80

< Electrical Characteristics >

($T_j = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Item	Conditions	Ratings			Unit
			Min.	Typ.	Max.	
I_{DRM}	Repetitive Peak Off-state Current	$T_j = 125^\circ\text{C}$, $V_D = V_{DRM}$,			5	mA
V_{TM}	Peak On-State Voltage	$I_T = 60\text{A}$, Instant measurement			1.4	V
I_{GT1^+}	QI	$V_D = 6\text{V}$, $I_T = 1\text{A}$			50	mA
I_{GT1^-}	QII				50	mA
I_{GT3^+}	QIV				-	mA
I_{GT3^-}	QIII				50	mA
V_{GT1^+}	QI	$V_D = 6\text{V}$, $I_T = 1\text{A}$			1.5	V
V_{GT1^-}	QII				1.5	V
V_{GT3^+}	QIV				-	V
V_{GT3^-}	QIII				1.5	V
V_{GD}	Non-Trigger Gate Voltage	$T_j = 125^\circ\text{C}$, $V_D = 1/2V_{DRM}$	0.2			V
dv/dt	Critical Rate of Rise of Off-State Voltage	$T_j = 125^\circ\text{C}$, $V_D = 1/2V_{DRM}$, Exponential wave	500			V/Fs
$(dv/dt)_c$	Critical Rate of Rise of Commutation Voltage	$T_j = 125^\circ\text{C}$, $V_D = 2/3V_{DRM}$, $(di/dt)_c = 10 \text{ A/ms}$	6			V/Fs
I_H	Holding Current			30		mA
$R_{th(j-c)}$	Thermal Resistance	Junction to case			1.3	°C/W



T: TAB250 ($T=6.35$, $T'=8.25$, $t=0.6$)

T': TAB250 ($T=6.35$, $T'=8.25$, $t=0.6$)

G: TAB167 ($T=4.75$, $T'=5.7$, $t=0.6$)

* Dimensions in millimeters